

7/30/01

MD 581.8

09/890483

18 Rec'd PCT/PTO 30 JUL 2001

09-11-2001

Form PTO-1595

(Rev. 03/01)

OMB No. 0651-0027 (exp. 5/31/2002)

Tab settings



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To the Honorable Commissioner of Patents and Trademarks, please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

OKAMOTO, Shinichi

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: May 28, 2001

2. Name and address of receiving party(ies)

Name: HIKARI TECH CO., LTD.

Internal Address:

Street Address: 4F, Yamamoto Bldg., 3-7,

Ueno 2-chome, Taito-ku

City: Tokyo State: Japan Zip: 110-0015

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is May 28, 2001

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

09/890483

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Richard M. Goldberg

Internal Address:

08/03/2001 MINGUYEN 00000062 071524 09090483

02 FC:581 40.00 CH

Street Address: 25 East Salem Street

Suite 419

City: Hackensack State: NJ Zip: 07601

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- ☐ Enclosed  
☒ Authorized to be charged to deposit account

8. Deposit account number:

07-1524

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard M. Goldberg

Name of Person Signing

Richard M. Goldberg July 30, 2001

Signature

Date

Total number of pages including cover sheet, attachments, and documents: 2

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks, Box Assignments  
Washington, D.C. 20231

# ASSIGNMENT

WHEREAS, I (We), Shinichi OKAMOTO

(NAMES OF ASSIGNORS),

residing at 193-2, Hasuda, Hasuda-shi, Saitama 349-0115 JAPAN

, have invented certain  
new and useful improvements in METHOD OF MANUFACTURING FERRULE

for which I (we) have executed an application for Letters Patent of the United States, of even date herewith; and

WHEREAS, HIKARI TECH CO., LTD.

4F, Yamamoto Bldg., 3-7, Higashi-Ueno 2-chome,

Taito-ku, Tokyo 110-0015 JAPAN

(NAME OF ASSIGNEE)

is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me (us) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I (we), the said

Shinichi OKAMOTO

(NAMES OF ASSIGNORS)

have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said

HIKARI TECH CO., LTD.

(NAME OF ASSIGNEE)

its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, including the right to claim priority under the terms of any appropriate International Convention based upon said application for Letters Patent of the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I (we) hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said

HIKARI TECH CO., LTD.

(NAME OF ASSIGNEE)

its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I (WE) HEREBY covenant that I (we) have full right to convey the entire interest herein assigned, and that I (we) have not executed, and will not execute, any agreement in conflict herewith.

AND I (WE) HEREBY further covenant and agree that I (we) will communicate to said

HIKARI TECH CO., LTD.

(NAME OF ASSIGNEE),

its successors, legal representatives and assigns, any facts known to me (us) respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute any divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said

HIKARI TECH CO., LTD.

(NAME OF ASSIGNEE),

its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I (we) hereunto set my (our) hand and seal the day and year set opposite thereto.

Date ✓ May 28, 2001, 2001 ✓ Shinichi Okamoto L.S.  
(SIGNATURE OF Shinichi OKAMOTO)